ON Semiconductor®



Silicon PNP Power Transistors

... for use in power amplifier and switching circuits, — excellent safe area limits. Complement to NPN 2N5191, 2N5192

*MAXIMUM RATINGS

Rating	Symbol	2N5194	2N5195	Unit
Collector-Emitter Voltage	VCEO	60	80	Vdc
Collector-Base Voltage	VCB	60	80	Vdc
Emitter–Base Voltage	V _{EB}	5.0		Vdc
Collector Current	IC	4.0		Adc
Base Current	ΙB	1.0		Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	40 320		Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150		°C/W

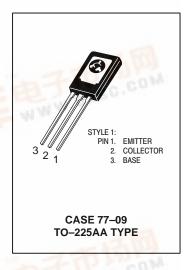
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	
Thermal Resistance, Junction to Case	θJC	3.12	°C/W	

2N5194 2N5195*

*ON Semiconductor Preferred Device

4 AMPERE POWER TRANSISTORS SILICON PNP 60–80 VOLTS



*ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS	MOS				
Collector–Emitter Sustaining Voltage (1) (I _C = 0.1 Adc, I _B = 0)	2N5194 2N5195	VCEO(sus)	60 80	_ _	Vdc
Collector Cutoff Current (VCE = 60 Vdc, IB = 0) (VCE = 80 Vdc, IB = 0)	2N5194 2N5195	ICEO		1.0	mAdc
Collector Cutoff Current (VCE = 60 Vdc, VBE(off) = 1.5 Vdc) (VCE = 80 Vdc, VBE(off) = 1.5 Vdc) (VCE = 60 Vdc, VBE(off) = 1.5 Vdc, TC = 125°C) (VCE = 80 Vdc, VBE(off) = 1.5 Vdc, TC = 125°C)	2N5194 2N5195 2N5194 2N5195	ICEX	= W	0.1 0.1 2.0 2.0	mAdc
Collector Cutoff Current (VCB = 60 Vdc, IE = 0) (VCB = 80 Vdc, IE = 0)	2N5194 2N5195	ICBO	_	0.1 0.1	mAdc
Emitter Cutoff Current (VBE = 5.0 Vdc, I _C = 0)		I _{EBO}	_	1.0	mAdc

^{*}Indicates JEDEC Registered Data.

⁽¹⁾ Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2.0\%$.



eferred devices are ON Semiconductor recommended choices for future use and best overall value.

*ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
ON CHARACTERISTICS			•	•	
DC Current Gain (2) (I _C = 1.5 Adc, V _{CE} = 2.0 Vdc) (I _C = 4.0 Adc, V _{CE} = 2.0 Vdc)	2N5194 2N5195 2N5194 2N5195	hFE	25 20 10 7.0	100 80 —	_
Collector–Emitter Saturation Voltage (2) (I _C = 1.5 Adc, I _B = 0.15 Adc) (I _C = 4.0 Adc, I _B = 1.0 Adc)		VCE(sat)		0.6 1.4	Vdc
Base–Emitter On Voltage (2) (I _C = 1.5 Adc, V _{CE} = 2.0 Vdc)		VBE(on)	_	1.2	Vdc
DYNAMIC CHARACTERISTICS					
Current–Gain — Bandwidth Product (IC = 1.0 Adc, V _{CE} = 10 Vdc, f = 1.0 MHz)		fΤ	2.0	_	MHz

^{*}Indicates JEDEC Registered Data.
(2) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

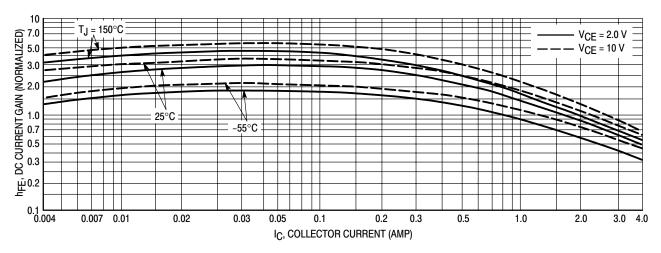


Figure 1. DC Current Gain

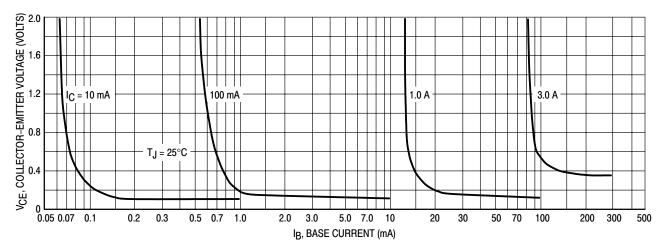


Figure 2. Collector Saturation Region

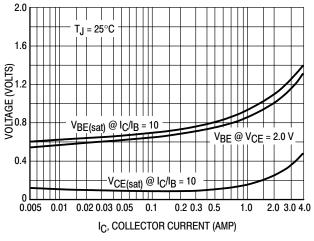


Figure 3. "On" Voltage

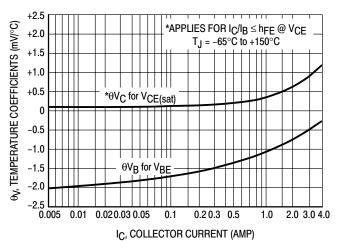


Figure 4. Temperature Coefficients

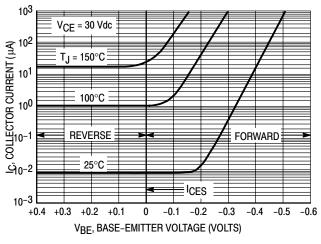


Figure 5. Collector Cut-Off Region

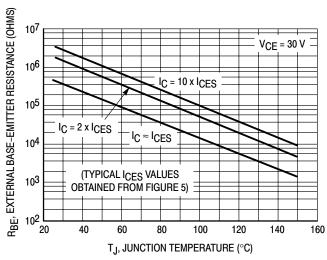


Figure 6. Effects of Base-Emitter Resistance

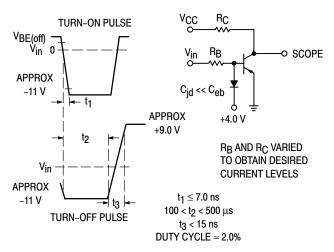


Figure 7. Switching Time Equivalent Test Circuit

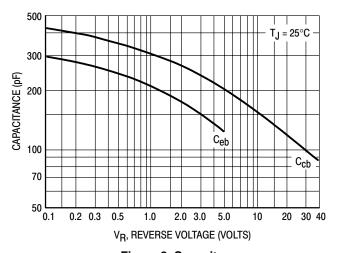


Figure 8. Capacitance

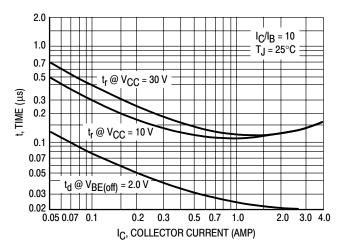


Figure 9. Turn-On Time

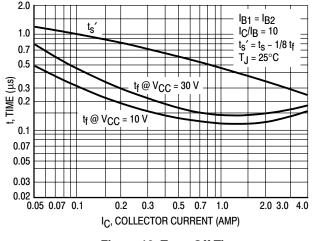


Figure 10. Turn-Off Time

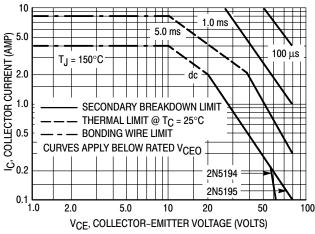


Figure 11. Rating and Thermal Data Active—Region Safe Operating Area

Note 1:

There are two limitations on the power handling ability of a transistor; average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 11 is based on $T_{J(pk)} = 150^{\circ}C$. T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. At high–case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

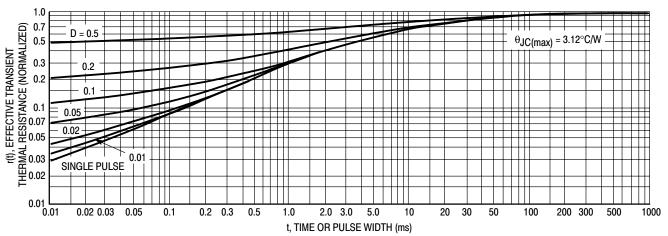


Figure 12. Thermal Response

DESIGN NOTE: USE OF TRANSIENT THERMAL RESISTANCE DATA

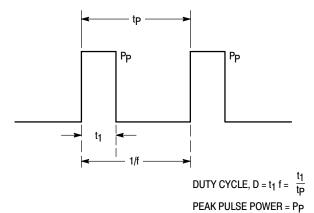


Figure 13.

A train of periodical power pulses can be represented by the model shown in Figure 13. Using the model and the device thermal response, the normalized effective transient thermal resistance of Figure 12 was calculated for various duty cycles.

To find $\theta JC(t)$, multiply the value obtained from Figure 12 by the steady state value θJC .

Example:

The 2N5193 is dissipating 50 watts under the following conditions: $t_1 = 0.1$ ms, $t_p = 0.5$ ms. (D = 0.2).

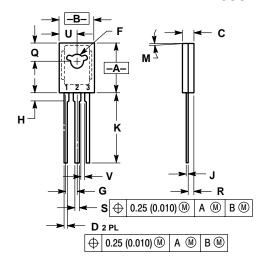
Using Figure 12, at a pulse width of 0.1 ms and D = 0.2, the reading of $r(t_1, D)$ is 0.27.

The peak rise in junction temperature is therefore:

$$\Delta T = r(t) \times PP \times \theta JC = 0.27 \times 50 \times 3.12 = 42.2 ^{\circ}C$$

PACKAGE DIMENSIONS

TO-225AA **CASE 77-09 ISSUE W**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.425	0.435	10.80	11.04	
В	0.295	0.305	7.50	7.74	
С	0.095	0.105	2.42	2.66	
D	0.020	0.026	0.51	0.66	
F	0.115	0.130	2.93	3.30	
G	0.094 BSC		2.39 BSC		
Н	0.050	0.095	1.27	2.41	
J	0.015	0.025	0.39	0.63	
K	0.575	0.655	14.61	16.63	
M	5°	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01	
R	0.045	0.065	1.15	1.65	
S	0.025	0.035	0.64	0.88	
U	0.145	0.155	3.69	3.93	
V	0.040		1.02		

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. BASE

Notes

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